## DUAL-CHANNEL, 10-BIT, 20/40MSPS A/D CONVERTER

is 10-bit, dual-channel A/D converter in deep submicron CMOS technology, 20/40Msps
is Single supply voltage: 2.5 V Independent supply for CMOS output stage with $2.5 \mathrm{~V} / 3.3 \mathrm{~V}$ capability
is ENOB=9.67 @ 20Msps, ENOB=9.4 @ 40 Msps , Fin $=10 \mathrm{MHz}$
is SFDR typically up to 62.5 dB @ 40Msps, Fin $=10 \mathrm{MHz}$.
is 1 GHz analog bandwidth Track-and-Hold
is Common clocking between channels
is Multiplexed outputs

## DESCRIPTION

The TSA1005 belongs to a new generation of high speed, dual-channel Analog to Digital converters, processed in a mainstream $0.25 \mu \mathrm{~m}$ CMOS technology and yielding high performances.
The TSA1005 is specifically designed for applications requiring a very low noise floor, high SFDR and good isolation between channels. It is based on a pipeline structure and digital error correction, providing high static linearity at 20/40 Msp, and Fin $=10 \mathrm{MHz}$.
For each channel, a voltage reference is integrated to simplify the design and minimize external components. It is nevertheless possible to use the circuit with external references.
Each ADC output is multiplexed on a common bus with small number of pins. A tri-state capability is available for the output signals, allowing for chip selection. The input signals of the ADC must be differentially driven.
The TSA1005 is supports an extended ( 0 to +85 C ) temperature range, and is available in the small 48-pin TQFP package.

## APPLICATIONS

is Medical imaging and ultrasound
is I/Q signal processing applications
is High speed data acquisition system
is Portable instrumentation
is High resolution fax and scanners

## ORDER CODE

| Part Number | Temperature <br> Range | Status | Conditioning |
| :--- | :---: | :---: | :---: |
| TSA1005-20IF | -40 C to +85 C | Sample | Tray |
| TSA1005-20IFT | -40 C to +85 C | Sample | Tape \& Reel |
| TSA1005I-40IF | 0 C to +85 C | Production | Tray |
| TSA1005-40IFT | 0 C to +85 C | Production | Tape \& Reel |
| EVAL1005-20/BA <br> EVAL1005-40/BA | Evaluation board |  |  |

PIN CONNECTIONS (top view)


## BLOCK DIAGRAM



## PACKAGE



ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Values | Unit |
| :---: | :--- | :---: | :---: |
| AVCC | Analog Supply voltage ${ }^{(1)}$ | 0 to 3.3 | V |
| DVCC | Digital Supply voltage ${ }^{1)}$ | 0 to 3.3 | V |
| VCCBE | Digital buffer Supply voltage ${ }^{1)}$ | 0 to 3.6 | V |
| VCCBI | Digital buffer Supply voltage ${ }^{1)}$ | 0 to 3.3 | V |
| IDout | Digital output current | -100 to 100 | mA |
| Tstg | Storage temperature | +150 | C |
| ESD | HBM: Human Body Model ${ }^{(2)}$ | 2 | kV |
| CDM: Charged Device Model ${ }^{(3)}$ | 1.5 | A |  |

1 All voltage values, except for differential voltage, are with respect to the network ground terminal. The magnitude of input and output voltages must not exceed -0.3 V or VCC
2 ElectroStatic Discharge pulse (ESD pulse) simulating a human body discharge of 100 pF through $1.5 \mathrm{k} \Omega$
3 Discharge to Ground of a device that has been previously charged.
4 Corporate ST Microelectronics procedure number 0018695
OPERATING CONDITIONS

| Symbol | Parameter | TSA1005-20 ${ }^{(1)}$ |  |  | TSA1005-40 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| AVCC | Analog Supply voltage | 2.25 | 2.5 | 2.7 | 2.25 | 2.5 | 2.7 | V |
| DVCC | Digital Supply voltage | 2.25 | 2.5 | 2.7 | 2.25 | 2.5 | 2.7 | V |
| VCCBE | External Digital buffer Supply voltage | 2.25 | 2.5 | 3.5 | 2.25 | 2.5 | 3.5 | V |
| VCCBI | Internal Digital buffer Supply voltage | 2.25 | 2.5 | 2.7 | 2.25 | 2.5 | 2.7 | V |
| VREFPI <br> VREFPQ | Forced top voltage reference | 0.94 |  | 1.4 | 0.94 |  | 1.4 | V |
| VREFMI VREFMQ | Forced bottom reference voltage | 0 |  | 0.4 | 0 |  | 0.4 | V |
| INCMI INCMQ | Forced input common mode voltage | 0.2 |  | 1 | 0.2 |  | 1 | V |

PIN CONNECTIONS (top view)


## PIN DESCRIPTION

| Pin No | Name | Description | Observation | Pin No | Name | Description | Observation |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | AGND | Analog ground | OV | 25 | GNDBE | Digital buffer ground | OV |
| 2 | INI | I channel analog input |  | 26 | VCCBE | Digital Buffer power supply | $2.5 \mathrm{~V} / 3.3 \mathrm{~V}$ |
| 3 | AGND | Analog ground | OV | 27 | D9(MSB) | Most Significant Bit output | CMOS output (2.5V/3.3V) |
| 4 | INBI | I channel inverted analog input |  | 28 | D8 | Digital output | CMOS output (2.5V/3.3V) |
| 5 | AGND | Analog ground | OV | 29 | D7 | Digital output | CMOS output (2.5V/3.3V) |
| 6 | IPOL | Analog bias current input |  | 30 | D6 | Digital output | CMOS output ( $2.5 \mathrm{~V} / 3.3 \mathrm{~V}$ ) |
| 7 | AVCC | Analog power supply | 2.5 V | 31 | D5 | Digital output | CMOS output ( $2.5 \mathrm{~V} / 3.3 \mathrm{~V}$ ) |
| 8 | AGND | Analog ground | OV | 32 | D4 | Digital output | CMOS output (2.5V/3.3V) |
| 9 | INQ | Q channel analog input |  | 33 | D3 | Digital output | CMOS output (2.5V/3.3V) |
| 10 | AGND | Analog ground | OV | 34 | D2 | Digital output | CMOS output (2.5V/3.3V) |
| 11 | INBQ | Q channel inverted analog input |  | 35 | D1 | Digital output | CMOS output (2.5V/3.3V) |
| 12 | AGND | Analog ground | OV | 36 | D0(LSB) | Least Significant Bit output | CMOS output (2.5V/3.3V) |
| 13 | REFPQ | Q channel top reference voltage |  | 37 | NC | Non connected |  |
| 14 | REFMQ | Q channel bottom reference voltage | OV | 38 | NC | Non connected |  |
| 15 | INCMQ | Q channel input common mode |  | 39 | VCCBE | Digital Buffer power supply | 2.5V/3.3V - See Application Note |
| 16 | AGND | Analog ground | 0 V | 40 | GNDBE | Digital buffer ground | OV |
| 17 | AVCC | Analog power supply | 2.5 V | 41 | VCCBI | Digital Buffer power supply | 2.5 V |
| 18 | DVCC | Digital power supply | 2.5 V | 42 | VCCBI | Digital Power Supply | 2.5 V |
| 19 | DGND | Digital ground | 0 V | 43 | OEB | Output Enable input | 2.5V/3.3V CMOS input |
| 20 | CLK | Clock input | 2.5 V CMOS input | 44 | AVCC | Analog power supply | 2.5 V |
| 21 | SELECT | Channel selection | 2.5V CMOS input | 45 | AVCC | Analog power supply | 2.5 V |
| 22 | DGND | Digital ground | 0 V | 46 | INCMI | I channel input common mode |  |
| 23 | DVCC | Digital power supply | 2.5 V | 47 | REFMI | I channel bottom reference voltage | OV |
| 24 | GNDBI | Digital buffer ground | 0 V | 48 | REFPI | I channel top reference voltage |  |

## ELECTRICAL CHARACTERISTICS

AVCC $=$ DVCC $=\mathrm{VCCB}=2.5 \mathrm{~V}, \mathrm{Fs}=20 / 40 \mathrm{Msps}$, Fin $=10.13 \mathrm{MHz}$, Vin@ -1 dBFS , VREFP $=0.8 \mathrm{~V}$, VREFM $=0 \mathrm{~V}$
Tamb $=25 \mathrm{C}$ (unless otherwise specified)

## TIMING CHARACTERISTICS

| Symbol | Parameter. | TSA1005-20(1) |  | TSA1005-40 |  |  |  |  |
| :---: | :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. | Unit |
| FS | Sampling Frequency | 0.5 |  | 20 | 0.5 |  | 40 | MHz |
| DC | Clock Duty Cycle |  | 50 |  | 45 | 50 | 55 | $\%$ |
| TC1 | Clock pulse width (high) |  | 25 |  |  | 12.5 |  | ns |
| TC2 | Clock pulse width (low) |  | 25 |  |  | 12.5 |  | ns |
| Tod | Data Output Delay (Clock edge to Data <br> Valid) - 10pF load capacitance |  | 5 |  |  | 5 |  | ns |
| Tpd I | Data Pipeline delay for I channel |  | 7 |  |  | 7 |  | cycles |
| Tpd Q | Data Pipeline delay for Q channel |  | 7.5 |  |  | 7.5 |  | cycles |
| Ton | Falling edge of OEB to digital output <br> valid data |  | 1 |  |  | 1 |  | ns |
| Toff | Rising edge of OEB to digital output <br> tri-state |  | 1 |  |  | 1 |  | ns |

1 Preliminary data.
TIMING DIAGRAM


## CONDITIONS

AVCC $=$ DVCC $=\mathrm{VCCB}=2.5 \mathrm{~V}, \mathrm{Fs}=20 / 40 \mathrm{Msps}$, Fin=2MHz, Vin@ -1 dBFS , VREFM=0V
Tamb $=25 \mathrm{C}$ (unless otherwise specified)

## ANALOG INPUTS

| Symbol | Parameter |  | TSA1005-20(1) |  |  | TSA1005-40 |  |  |
| :---: | :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. | Unit |
| VIN-VINB | Full scale reference voltage | 1.1 | 2.0 | 2.8 | 1.1 | 2.0 | 2.8 | Vpp |
| Cin | Input capacitance |  | 7.0 |  |  | 7 |  | pF |
| Req | Equivalent input resistor |  | 3.3 |  |  | 1.6 |  | $\mathrm{~K} \Omega$ |
| BW | Analog Input Bandwidth <br> Vin Full scale, Fs max |  | 1000 |  |  | 1000 |  | MHz |
| ERB | Effective Resolution Bandwidth |  | 70 |  |  | 70 |  | MHz |

1 Preliminary data
DIGITAL INPUTS AND OUTPUTS

| Symbol | Parameter | Test conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Clock and Select inputs |  |  |  |  |  |  |
| VIL | Logic "0" voltage |  |  | 0 | 0.8 | V |
| VIH | Logic "1" voltage |  | 2.0 | 2.5 |  | V |
| OEB input |  |  |  |  |  |  |
| VIL | Logic "0" voltage |  |  | 0 | $\begin{array}{\|c\|} \hline 0.25 x \\ \text { VCCBE } \\ \hline \end{array}$ | V |
| VIH | Logic "1" voltage |  | $\begin{array}{\|c\|} \hline 0.75 \mathrm{x} \\ \text { VCCBE } \end{array}$ | vccbe |  | V |
| Digital Outputs |  |  |  |  |  |  |
| VOL | Logic "0" voltage | $\mathrm{lol}=10 \mu \mathrm{~A}$ |  | 0 | $\begin{array}{\|c\|} \hline 0.1 \mathrm{x} \\ \text { VCCBE } \end{array}$ | V |
| VOH | Logic "1" voltage | loh=10 A | $\begin{array}{\|c\|} \hline 0.9 x \\ \text { VCCBE } \\ \hline \end{array}$ | VCCBE |  | V |
| IOZ | High Impedance leakage current | OEB set to VIH | -1.67 | 0 | 1.67 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{L}}$ | Output Load Capacitance |  |  |  | 15 | pF |

## REFERENCE VOLTAGE

| Symbol | Parameter | TSA1005-20(1) |  |  | TSA1005-40 |  |  |  |
| :---: | :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. | Unit |
| VREFPI <br> VREFPQ | Top internal reference voltage | 0.81 | 0.88 | 0.94 | 0.81 | 0.88 | 0.94 | V |
| VINCMI <br> VINCMQ | Input common mode voltage | 0.41 | 0.46 | 0.50 | 0.41 | 0.46 | 0.50 | V |

## CONDITIONS

AVCC $=$ DVCC $=$ VCCB $=2.5 \mathrm{~V}, \mathrm{Fs}=20 / 40 \mathrm{Msps}$, Fin=2MHz, Vin@ -1 dBFS , VREFP=0.8V, VREFM=0V Tamb $=25 \mathrm{C}$ (unless otherwise specified)

## POWER CONSUMPTION

| Symbol | Parameter | TSA1005-20 ${ }^{(1)}$ |  |  | TSA1005-40 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| ICCA | Analog Supply current |  | 30 |  |  | 69.5 | 77.1 | mA |
| ICCD | Digital Supply Current |  | 4 |  |  | 3.5 | 3.77 | mA |
| ICCBE | Digital Buffer Supply Current (10pF load) |  | 6 |  |  | 6.5 | 7.66 | mA |
| ICCBI | Digital Buffer Supply Current |  | 274 |  |  | 131 | 176 | $\mu \mathrm{A}$ |
| Pd | Power consumption in normal operation mode |  | 100 |  |  | 199.5 | 218.6 | mW |
| Rthja | Thermal resistance (TQFP48) | - | 80 |  |  | 80 |  | C/W |

## ACCURACY

| Symbol | Parameter | TSA1005-20(1) |  | TSA1005-40 |  |  |  |  |
| :---: | :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. | Unit |
| OE | Offset Error |  | 2.97 |  |  | 2.97 |  | LSB |
| GE | Gain Error |  | 0.1 |  |  | 0.1 |  | $\%$ |
| DNL | Differential Non Linearity |  | $\pm 0.5$ |  |  | $\pm 0.6$ |  | LSB |
| INL | Integral Non Linearity |  | $\pm 0.7$ |  |  | $\pm 1$ |  | LSB |
| - | Monotonicity and no missing codes | Guaranteed |  | Guaranteed |  |  |  |  |

## DYNAMIC CHARACTERISTICS

|  | Symbol | TSA1005-20 ${ }^{(1)}$ |  |  | TSA1005-40 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| SFDR | Spurious Free Dynamic Range |  | -73 |  |  | -62.6 | -58.1 | dBc |
| SNR | Signal to Noise Ratio |  | 60 |  | 57.1 | 59.8 |  | dB |
| THD | Total Harmonics Distortion |  | -73 |  |  | -62 | -57.5 | dBc |
| SINAD | Signal to Noise and Distortion Ratio |  | 59 |  | 54.9 | 57.3 |  | dB |
| ENOB | Effective number of bits |  | 9.67 |  | 8.8 | 9.4 |  | bits |

## MATCHING BETWEEN CHANNELS

| Symbol | Parameter | TSA1005-20 ${ }^{(1)}$ |  |  | TSA 1005-40 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| GM | Gain match |  | 0.04 |  |  | 0.04 | 1 | \% |
| OM | Offset match |  | 0.5 |  |  | 0.5 |  | LSB |
| PHM | Phase match |  | 1 |  |  | 1 |  | dg |
| XTLK | Crosstalk rejection |  | 85 |  |  | 85 |  | dB |

[^0]
## Static parameter: Integral Non Linearity

Fs=20MSPS; Icca=30mA; Fin=10MHz


Static parameter: Integral Non Linearity
Fs=40MSPS; Icca=45mA; Fin=10MHz


Static parameter: Differential Non Linearity
Fs=20MSPS; Icca=30mA; Fin=10MHz


Static parameter: Differential Non Linearity
Fs=40MSPS; Icca=45mA; Fin=10MHz


Linearity vs. Fin
Fs=20MHz; Icca=30mA


Linearity vs. Fin
Fs=40MHz; Icca=45mA


Distortion vs. Fin
Fs=20MHz; Icca=30mA


Distortion vs. Fin
Fs=40MHz; Icca=45mA


Linearity vs. AVCC
Fs=20MSPS; Icca=30mA; Fin=5MHz


Linearity vs. AVCC
Fs=40MSPS; Icca=45mA; Fin=5MHz


Linearity vs. DVCC
Fs=20MSPS; Icca=30mA; Fin=10MHz


Distortion vs. AVCC
Fs=20MSPS; Icca=30mA; Fin=5MHz


## Distortion vs. AVCC

Fs=40MSPS; Icca=45mA; Fin=5MHz


## Distortion vs. DVCC

Fs=20MSPS; Icca=30mA; Fin=10MHz


Linearity vs. DVCC
Fs=40MSPS; Icca=45mA; Fin=10MHz


Linearity vs. VCCBI
Fs=20MSPS; Icca=30mA; Fin=10MHz


Linearity vs. VCCBI
Fs=40MSPS; Icca=45mA; Fin=10MHz


Distortion vs. DVCC
Fs=40MSPS; Icca=45mA; Fin=10MHz


Distortion vs. VCCBI
Fs=20MSPS; Icca=30mA; Fin=10MHz


## Distortion vs. VCCBI

Fs=40MSPS; Icca=45mA; Fin=10MHz


Linearity vs. VCCBE
Fs=20MSPS; Icca=30mA; Fin=10MHz


Linearity vs. VCCBE
Fs=40MSPS; Icca=45mA; Fin=10MHz


Linearity vs. Duty Cycle
Fs=20MHz; Icca=30mA; Fin=5MHz


## Distortion vs. VCCBE

Fs=20MSPS; Icca=30mA; Fin=10MHz


Distortion vs. VCCBE
Fs=40MSPS; Icca=45mA; Fin=10MHz


Distortion vs. Duty Cycle
Fs $=20 \mathrm{MHz}$; Icca=30mA; Fin=5MHz


## Linearity vs. Duty Cycle

Fs=40MHz; Icca=45mA; Fin=5MHz


Distortion vs. Duty Cycle
Fs=40MHz; Icca=45mA; Fin=5MHz


## Single-tone 8K FFT at 24.8Msps - Q Channel

Fin $=10 \mathrm{MHz}$; Icca=30mA, Vin@-1dBFS


Single-tone 8K FFT at 39.7Msps - Q Channel
Fin=10MHz; Icca=45mA, Vin@-1dBFS


## DEFINITIONS OF SPECIFIED PARAMETERS

## STATIC PARAMETERS

Static measurements are performed using a histogram method with on a 2 MHz input signal, sampled at 40 Msps , which is high enough to fully characterize the test frequency response. An input level of +1 dBFS is required to saturate the signal.

## Differential Non Linearity (DNL)

The average deviation of any output code width from the ideal code width of 1 LSB.

## Integral Non linearity (INL)

An ideal converter presents a transfer function as being the straight line from the starting code to the ending code. The INL is the deviation for each transition from this ideal curve.

## DYNAMIC PARAMETERS

Dynamic measurements are performed by spectral analysis, applied to an input sine wave of various frequencies and sampled at 40 Msps .
The input level is -1 dBFS to measure the linear behavior of the converter. All the parameters are given without correction for the full scale amplitude performance except the calculated ENOB parameter.

## Spurious Free Dynamic Range (SFDR)

The ratio between the power of the worst spurious signal (not always an harmonic) and the amplitude of fundamental tone (signal power) over the full Nyquist band. It is expressed in dBc .

## Total Harmonic Distortion (THD)

The ratio of the rms sum of the first five harmonic distortion components to the rms value of the fundamental line. It is expressed in dB .

## Signal to Noise Ratio (SNR)

The ratio of the rms value of the fundamental component to the rms sum of all other spectral
components in the Nyquist band ( $\mathrm{f}_{\mathrm{s}} / 2$ ) excluding DC, fundamental and the first five harmonics. SNR is reported in dB.

## Signal to Noise and Distortion Ratio (SINAD)

Similar ratio as for SNR but including the harmonic distortion components in the noise figure (not DC signal). It is expressed in dB .
From the SINAD, the Effective Number of Bits (ENOB) can easily be deduced using the formula:

$$
\text { SINAD }=6.02 \times \mathrm{ENOB}+1.76 \mathrm{~dB} .
$$

When the applied signal is not Full Scale (FS), but has an $A_{0}$ amplitude, the SINAD expression becomes:

$$
\begin{aligned}
& \text { SINAD }_{2 A 0}=\text { SINAD Full Scale }+20 \log \left(2 A_{0} / F S\right) \\
& \text { SINAD }_{2 A 0}=6.02 \times E N O B+1.76 \mathrm{~dB}+20 \log \left(2 \mathrm{~A}_{0} / \mathrm{FS}\right)
\end{aligned}
$$

The ENOB is expressed in bits.

## Analog Input Bandwidth

The maximum analog input frequency at which the spectral response of a full power signal is reduced by 3 dB . Higher values can be achieved with smaller input levels.

## Effective Resolution Bandwidth (ERB)

The band of input signal frequencies that the ADC is intended to convert without loosing linearity i.e. the maximum analog input frequency at which the SINAD is decreased by 3 dB or the ENOB by $1 / 2$ bit.

## Pipeline delay

Delay between the initial sample of the analog input and the availability of the corresponding digital data output, on the output bus. Also called data latency. It is expressed as a number of clock cycles.

## TSA1005 APPLICATIOI':'OTE

## DETAILED INFORMATION

The TSA1005 is a dual-channel, 10-bit resolution analog to digital converter based on a pipeline structure and the latest deep sub micron CMOS process to achieve the best performances in terms of linearity and power consumption.
Each channel achieves 10-bit resolution through the pipeline structure. A latency time of 7 clock periods is necessary to obtain the digitized data on the output bus.
The input signals are simultaneously sampled on both channels on the rising edge of the clock. The output data is valid on the rising edge of the clock for I channel and on the falling edge of the clock for $Q$ channel. The digital data out from the different stages must be time delayed depending on their order of conversion. Then a digital data correction completes the processing and ensures the validity of the ending codes on the output bus.
The structure has been specifically designed to accept differential signals.
The TSA1005 is pin to pin compatible with the dual 12bits/20Msps TSA1204 and the dual 12bits/ 40Msps TSA1203.

## COMPLEMENTARY FUNCTIONS

Some functionalities have been added in order to simplify as much as possible the application board. These operational modes are described as followed.

## Output Enable (OEB)

When set to low level (VIL), all digital outputs remain active and are in low impedance state. When set to high level (VIH), all digital outputs buffers are in high impedance state while the converter goes on sampling. When OEB is set to a low level again, the data are then present on the output with a very short Ton delay.
Therefore, this allows the chip select of the device. The timing diagram summarizes this functionality. In order to remain in the normal operating mode, this pin should be grounded through a low value of resistor.

## SELECT

The digital data out from each ADC core are multiplexed together to share the same output bus. This prevents from increasing the number of pins
and enables to keep the same package as single channel ADC like TSA1002.

The selection of the channel information is done through the "SELECT" pin. When set to high level (VIH), the I channel data are present on the bus D0-D9. When set to low level (VIL), the Q channel data are on the output bus D0-D9.

Connecting SELECT to CLK allows I and Q channels to be simultaneously present on D0-D9; I channel on the rising edge of the clock and Q channel on the falling edge of the clock. (see timing diagram page 2 ).

## REFERENCES AND COMMON MODE CONNECTION

VREFM must be always connected externally.

## Internal reference and common mode

In the default configuration, the ADC operates with its own reference and common mode voltages generated by its internal bandgap. VREFM pins are connected externally to the Analog Ground while VREFP (respectively INCM) are set to their internal voltage of 0.88 V (respectively 0.46 V ). It is recommended to decouple the VREFP and INCM in order to minimize low and high frequency noise (refer to Figure 1)

Figure 1: Internal reference and common mode setting


## External reference and common mode

Each of the voltages VREFP and INCM can be fixed externally to better fit to the application needs (Refer to table íOPERATING CONDITIONSí page 4 for min/max values).
The VREFP, VREFM voltages set the analog dynamic at the input of the converter that has a full scale amplitude of $2^{*}(V R E F P-V R E F M)$. Using internal references, the dynamic range is 1.8 V .
The INCM is the mid voltage of the analog input signal.
It is possible to use an external reference voltage device for specific applications requiring even better linearity, accuracy or enhanced temperature behavior.
Using the STMicroelectronics TS821 or TS4041-1.2 Vref leads to optimum performances when configured as shown on Figure 2.

Figure 2: External reference setting


## DRIVING THE DIFFERENTIAL ANALOG INPUTS

The TSA1005 has been designed to obtain optimum performances when being differentially driven. An RF transformer is a good way to achieve such performances.
Figure 3 describes the schematics. The input signal is fed to the primary of the transformer, while the secondary drives both ADC inputs. The common mode voltage of the ADC (INCM) is connected to the center-tap of the secondary of the transformer in order to bias the input signal around this common voltage, internally set to 0.46 V . It determines the DC component of the analog signal. As being an high impedance input, it acts as an I/O and can be externally driven to adjust this DC component. The INCM is decoupled to maintain a low noise level on this node. Our evaluation board is mounted with a $1: 1$ ADT1-1WT transformer from Minicircuits. You might also use a higher impedance ratio (1:2 or
$1: 4)$ to reduce the driving requirement on the analog signal source.

Each analog input can drive a 1.4Vpp amplitude input signal, so the resultant differential amplitude is 2.8 Vpp .

Figure 3: Differential input configuration with transformer


Figure 4 represents the biasing of a differential input signal in AC-coupled differential input configuration. Both inputs VIN and VINB are centered around the common mode voltage, that can be let internal or fixed externally.

Figure 4: AC-coupled differential input


Figure 5: AC-coupled Single-ended input


## Clock input

The TSA1005 performance is very dependant on your clock input accuracy, in terms of aperture jitter; the use of low jitter crystal controlled oscillator is recommended.

The duty cycle must be between $45 \%$ and $55 \%$.
The clock power supplies must be separated from the ADC output ones to avoid digital noise modulation at the output.

It is recommended to always keep the circuit clocked, even at the lowest specified sampling frequency of 0.5 Msps , before applying the supply voltages.

## Power consumption

So as to optimize both performance and power consumption of the TSA1005 according the sampling frequency, a resistor is placed between IPOL and the analog Ground pins. Therefore, the total dissipation is adjustable from 5 Msps up to 40Msps.

The TSA1005 will combine highest performances and lowest consumption at 20 Msps when Rool is equal to $70 \mathrm{k} \Omega$, at 40 Msps when Rpol is equal to $35 \mathrm{k} \Omega$. These values are nevertheless dependant on application and environment.

At lower sampling frequency range, this value of resistor may be adjusted in order to decrease the analog current without any degradation of dynamic performances.

The figure 6 sums up the relevant data.
Figure 6: analog current consumption optimization depending on Rpol value


## APPLICATION

## Layout precautions

To use the ADC circuits in the best manner at high frequencies, some precautions have to be taken for power supplies:

- First of all, the implementation of 4 separate proper supplies and ground planes (analog, digital, internal and external buffer ones) on the PCB is recommended for high speed circuit applications to provide low inductance and low resistance common return.
The separation of the analog signal from the digital part is mandatory to prevent noise from coupling onto the input signal. The best compromise is to connect from one part AGND, DGND, GNDBI in a common point whereas GNDBE must be isolated. Similarly, the power supplies AVCC, DVCC and VCCBI must be separated from the VCCBE one.
- Power supply bypass capacitors must be placed as close as possible to the IC pins in order to improve high frequency bypassing and reduce harmonic distortion.
- Proper termination of all inputs and outputs must be incorporated with output termination resistors; then the amplifier load will be only resistive and the stability of the amplifier will be improved. All leads must be wide and as short as possible especially for the analog input in order to decrease parasitic capacitance and inductance.
- To keep the capacitive loading as low as possible at digital outputs, short lead lengths of routing are essential to minimize currents when the output changes. To minimize this output capacitance, buffers or latches close to the output pins will relax this constraint.
- Choose component sizes as small as possible (SMD).


## Digital Interface application

Thanks to its wide external buffer power supply range, the TSA1005 is perfectly suitable to plug in to 2.5 V low voltage DSPs or digital interfaces as well as to 3.3 V ones.

## Medical Imaging application

Driven by the demand of the applications requiring nowadays either portability or high degree of parallelism (or both), this product has been developed to satisfy medical imaging, and telecom infrastructures needs.
As a typical system diagram shows figure 10, a narrow input beam of acoustic energy is sent into a living body via the transducer and the energy reflected back is analyzed.

Figure 7: Medical imaging application


The transducer is a piezoelectric ceramic such as zirconium titanate. The whole array can reach up to 512 channels.
The TX beam former, amplified by the HV TX amps, delivers up to 100 V amplitude excitation pulses with phase and amplitude shifts.
The mux and $T / R$ switch is a two way input signal transmitter/ output receiver.
To compensate for skin and tissues attenuation effects, The Time Gain Compensation (TGC) amplifier is an exponential amplifier that enables the amplification of low voltage signals to the ADC input range. Differential output structure with low
noise and very high linearity are mandatory factors.
These applications need high speed, low power and high performance ADCs. 10-12 bit resolution is necessary to lower the quantification noise. As multiple channels are used, a dual converter is a must for room saving issues.
The input signal is in the range of 2 to 20 MHz (mainly 2 to 7 MHz ) and the application uses mostly a 4 over-sampling ratio for Spurious Free Dynamic Range (SFDR) optimization.
The next RX beam former and processing blocks enable the analysis of the outputs channels versus the input beam.

## EVAL1005/BA evaluation board

The EVAL1005/BA is a 4-layer board with high decoupling and grounding level. The schematic of the evaluation board is reported figure 11 and its top overlay view figure 10. The characterization of the board has been made with a fully ADC devoted test bench as shown on Figure 8. The analog input signal must be filtered to be very pure.
The dataready signal is the acquisition clock of the logic analyzer.
The ADC digital outputs are latched by the octal buffers 74LCX573.
All characterization measurements have been made with:

- SFSR=1dB for static parameters.
- SFSR=-1dB for dynamic parameters.

Figure 8: Analog to Digital Converter characterization bench


## Operating conditions of the evaluation board:

Find below the connections to the board for the power supplies and other pins:

| board <br> notation | connection | internal <br> voltage (V) | external <br> voltage (V) |
| :---: | :---: | :---: | :---: |
| AV | AVCC |  | 2.5 |
| AG | AGND |  | 0 |
| RPI | REFPI | 0.88 | 0.94 to 1.4 |
| RMI | REFMI |  | 0 to 0.4 |
| CMI | INCMI | 0.46 | 0.2 to 1 |
| RPQ | REFPQ | 0.88 | 0.94 to 1.4 |
| RMQ | REFMQ |  | 0 to 0.4 |
| CMQ | INCMQ | 0.46 | 0.2 to 1 |
| DV | DVCC |  | 2.5 |
| DG | DGND |  | 0 |
| GB1 | GNDBI |  | 0 |
| VB1 | VCCBI |  | 2.5 |
| GB2 | GNDBE |  | 0 |
| VB2 | VCCBE |  | $2.5 / 3.3$ |
| GB3 | GNDB3 |  | 0 |
| VB3 | VCCB3 |  | 2.5 |

Care should be taken for the evaluation board considering the fact that the outputs of the converter are $2.5 \mathrm{~V} / 3.3 \mathrm{~V}$ (VB2) tolerant whereas the 74LCX573 external buffers are operating up to 2.5 V .

The ADC outputs on the connector J6 are D11 (MSB) to D2 (LSB).

## Single and Differential Inputs:

The ADC board components are mounted to test the TSA1005 with single analog input; the ADT1-1WT transformer enables the differential drive into the converter; in this configuration, the resistors RSI6, RSI7, RSI8 for I channel (respectively RSQ6, RSQ7, RSQ8 for Q one) are connected as short circuits whereas RSI5, RSI9 (respectively RSQ5, RSQ9) are open circuits.
The other way is to test it via JI1 and JI1B differential inputs. So, the resistances RSI5, RSI9 for I channel (respectively RSQ5, RSQ9 for Q one) are connected as short circuits whereas RSI6, RSI7, RSI8 (respectively RSQ6, RSQ7, RSQ8 for Q one) are open circuits.

## Grounding consideration

So as to better reject noise on the board, connect on the bottom overlay AG (AGND), DG(DGND), GB1(GNDBI) together from one part, and GB2(GNDBE) with GB3(GNDB3) from the other part.

## Mode select

So as to evaluate a single channel or the dual ones, you have to connect on the board the relevant position for the SELECT pin.
With the strap connected:

- to the upper connectors, the I channel at the output is selected.
- horizontally, the Q channel at the output is selected.
- to the lower connectors, both channels are selected, relative to the clock edge.

Figure 9: mode select


## Consumption adjustment

Before any characterization, care should be taken to adjust the Rpol (Raj1) and therefore lpol value in function of your sampling frequency.

Figure 10: Printed circuit of evaluation board.


Figure 11:TSA1005 Evaluation board schematic


Figure 12: Printed circuit board - List of components

| Name | Part | Footprint | Name | Part | Footprint | Name | Part | Footprint | Name | Part | Footprint |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Type |  |  | Type |  |  | Type |  |  | Type |  |
| RSQ6 | 0 | 805 | CD2 | 10nF | 603 | C26 | 330pF | 603 | CQ6 | NC | 805 |
| RSQ7 | 0 | 805 | C40 | 10nF | 603 | C20 | 330pF | 603 | CI6 | NC | 805 |
| RSQ8 | 0 | 805 | C39 | 10nF | 603 | C33 | 330pF | 603 | U2 | 74LCX573 | TSSOP20 |
| RSI6 | 0 | 805 | CQ12 | 10nF | 603 | C25 | 330pF | 603 | U3 | 74LCX573 | TSSOP20 |
| RSI7 | 0 | 805 | CQ9 | 10nF | 603 | Cl 1 | 33pF | 603 | U1 | STG719 | SOT23-6 |
| RSI8 | 0 | 805 | C52 | 10nF | 603 | CQ1 | 33pF | 603 | JA | ANALOGIC | connector |
| R3 | 47 | 603 | C18 | 10nF | 603 | C34 | $47 \mu \mathrm{~F}$ | RB. 1 | J17 | BUFPOW | connector |
| R5 | 47 | 603 | C21 | 10nF | 603 | C42 | $47 \mu \mathrm{~F}$ | RB. 1 | J25 | CKDATA | SMA |
| RQ19 | 47 | 603 | C4 | 10nF | 603 | C35 | $47 \mu \mathrm{~F}$ | RB. 1 | J4 | CLK | SMA |
| RI1 | 47 | 603 | C15 | 10nF | 603 | C44 | $47 \mu \mathrm{~F}$ | RB. 1 | J27 | CON2 | SIP2 |
| RQ1 | 47 | 603 | C27 | 10nF | 603 | C36 | $47 \mu \mathrm{~F}$ | RB. 1 | J26 | CON2 | SIP2 |
| RI19 | 47 | 603 | C11 | 10nF | 603 | C32 | $47 \mu \mathrm{~F}$ | RB. 1 | JD | DIGITAL | connector |
| RSI9 | ONC | 805 | CI9 | 10nF | 603 | C37 | 470nF | 805 | JI1 | InI | SMA |
| RSQ5 | ONC | 805 | Cl12 | 10nF | 603 | CQ10 | 470nF | 805 | J11B | InIB | SMA |
| RSQ9 | ONC | 805 | Cl31 | 10nF | 603 | C28 | 470nF | 805 | JQ1 | $\ln \mathrm{Q}$ | SMA |
| RSI5 | ONC | 805 | CQ31 | 10nF | 603 | CI10 | 470nF | 805 | JQ1B | InQB | SMA |
| R24 | ONC | 805 | CQ30 | 330pF | 603 | CQ32 | 470nF | 805 | SW1 | SWITCH | connector |
| R23 | ONC | 805 | CI11 | 330pF | 603 | CQ13 | 470nF | 805 | S5 | SW-SPST | connector |
| R21 | ONC | 805 | C51 | 330 pF | 603 | CI32 | 470nF | 805 | S4 | SW-SPST | connector |
| R22 | ONC | 805 | C2 | 330pF | 603 | C13 | 470nF | 805 | TI2 | T2-AT1-1WT | ADT |
| R2 | 1K | 603 | C17 | 330pF | 603 | C53 | 470nF | 805 | TQ2 | T2-AT1-1WT | ADT |
| R12 | 47K | 603 | CD3 | 330 pF | 603 | C16 | 470nF | 805 | JI2 | VREFI | connector |
| R11 | 47K | 603 | C10 | 330 pF | 603 | C3 | 470nF | 805 | JQ2 | VREFQ | connector |
| Raj1 | 200K | VR5 <br> trimmer | CQ8 | 330pF | 603 | C22 | 470nF | 805 | J6 | 32Pin | IDC-32 connector |
|  |  |  | CQ11 | 330 pF | 603 | Cl13 | 470nF | 805 |  |  |  |
| C23 | 10 $\mu \mathrm{F}$ | 1210 | CI8 | 330pF | 603 | C38 | 470nF | 805 |  |  |  |
| C41 | $10 \mu \mathrm{~F}$ | 1210 | C14 | 330pF | 603 | CD1 | 470nF | 805 |  | NC: non soldered |  |
| C29 | $10 \mu \mathrm{~F}$ | 1210 | Cl30 | 330pF | 603 | C19 | 470nF | 805 |  |  |  |

## PACKAGE MECHANICAL DATA

74) 3 0 ( \& + \$1, \& \$/ '\$7

| '0 | PP |  |  | LQK |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 0,1 | 7<3 | 0 \$; | 0,1 | 7<3 | 0\$; |
| \$ |  |  |  |  |  |  |
| \$ |  |  |  |  |  |  |
| \$ |  |  |  |  |  |  |
| \% |  |  |  |  |  |  |
| \& |  |  |  |  |  |  |
| , |  |  |  |  |  |  |
| ' |  |  |  |  |  |  |
| ' |  |  |  |  |  |  |
| H |  |  |  |  |  |  |
| $($ |  |  |  |  |  |  |
| ( |  |  |  |  |  |  |
| ( |  |  |  |  |  |  |
| 1 |  |  |  |  |  |  |
| 1 |  |  |  |  |  |  |
| . | , | , | , | , | , | , |



Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics

## © 2003 STMicroelectronics - Printed in Italy - All Rights Reserved STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - China - Finland - France - Germany - Hong Kong - India - Italy - Japan - Malaysia - Malta - Morocco Singapore - Spain - Sweden - Switzerland - United Kingdom


[^0]:    1 Preliminary data

